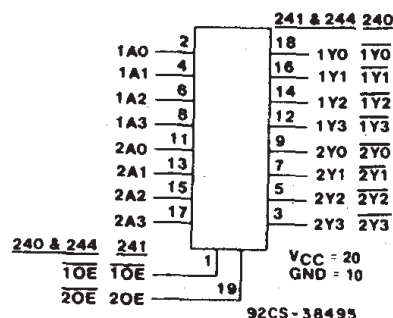


# CD54/74AC240/241/244

## CD54/74ACT240/241/244



Data sheet acquired from Harris Semiconductor  
SCHS287B – Revised January 2004



**FUNCTIONAL DIAGRAM & TERMINAL ASSIGNMENT**

The RCA CD54/74AC240, CD54/74AC241, and CD54/74AC244 and the CD54/74ACT240, CD54/74ACT241, and CD54/74ACT244 3-state octal buffer/line drivers use the RCA ADVANCED CMOS technology. The CD54/74AC/ACT240 and CD54/74AC/ACT244 have active-LOW output enables ( $\overline{1OE}$ ,  $\overline{2OE}$ ). The CD54/74AC/ACT241 has one active-LOW ( $\overline{1OE}$ ) and one active-HIGH ( $\overline{2OE}$ ) output enable.

The CD74AC240 and CD74ACT240 are supplied in 20-lead dual-in-line plastic packages (E suffix) and 20-lead small-outline packages (M and M96 suffixes). The CD74AC241 is supplied in 20-lead dual-in-line plastic packages (E suffix) and 20-lead small-outline packages (M96 suffix). The CD74AC244 and CD74ACT244 are supplied in 20-lead dual-in-line plastic packages (E suffix), 20-lead small-outline packages (M and M96 suffixes), and 20-lead shrink small-outline packages (SM96 suffix). These package types are operable over the following temperature ranges: Commercial (0 to 70°C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC240 and CD54AC244 and the CD54ACT240, CD54ACT241, and CD54ACT244 are supplied in 20-lead hermetic dual-in-line ceramic packages (F3A suffix) and are operable over the -55 to +125°C temperature range.

### Type Features:

- Buffered inputs
- Typical propagation delay:  
3.6 ns @  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $C_L = 50\text{ pF}$

### Family Features:

- Exceeds 2-kV ESD Protection - MIL-STD-883, Method 3015
- SCR-Latch-up-resistant CMOS process and circuit design
- Speed of bipolar FAST<sup>®</sup>/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- $\pm 24\text{-mA}$  output drive current
  - Fanout to 15 FAST<sup>®</sup> ICs
  - Drives 50-ohm transmission lines

\*FAST is a Registered Trademark of Fairchild Semiconductor Corp.

### TRUTH TABLES

| INPUTS                              |   | OUTPUT |  |
|-------------------------------------|---|--------|--|
| $\overline{1OE}$ , $\overline{2OE}$ | A | Y      |  |
| L                                   | L | H      |  |
| L                                   | H | L      |  |
| H                                   | X | Z      |  |

(AC/ACT240)

| INPUTS                              |   | OUTPUT |  |
|-------------------------------------|---|--------|--|
| $\overline{1OE}$ , $\overline{2OE}$ | A | Y      |  |
| L                                   | L | L      |  |
| L                                   | H | H      |  |
| H                                   | X | Z      |  |

(AC/ACT244)

| INPUTS           |    | OUTPUT |     | INPUTS |    | OUTPUT |  |
|------------------|----|--------|-----|--------|----|--------|--|
| $\overline{1OE}$ | 1A | 1Y     | 2OE | 2A     | 2Y |        |  |
| L                | L  | L      | L   | X      | Z  |        |  |
| L                | H  | H      | H   | L      | L  |        |  |
| H                | X  | Z      | H   | H      | H  |        |  |

(AC/ACT241)

H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Immaterial  
Z = HIGH Impedance

This data sheet is applicable to the CD54/74AC240, CD54ACT240, and CD54/74ACT241. The CD54/74AC241 were not acquired from Harris Semiconductor. See SCHS244 for information on the CD74ACT240, CD74AC244, and CD74ACT244.

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# CD54/74AC240/241/244

## CD54/74ACT240/241/244

**MAXIMUM RATINGS, Absolute-Maximum Values:**

|                                                                                                           |                                                     |
|-----------------------------------------------------------------------------------------------------------|-----------------------------------------------------|
| DC SUPPLY-VOLTAGE ( $V_{CC}$ )                                                                            | -0.5 to 6 V                                         |
| DC INPUT DIODE CURRENT, $I_{IK}$ (for $V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V)                           | $\pm 20$ mA                                         |
| DC OUTPUT DIODE CURRENT, $I_{OK}$ (for $V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V)                          | $\pm 50$ mA                                         |
| DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, $I_O$ (for $V_O > -0.5$ V or $V_O < V_{CC} + 0.5$ V)     | $\pm 50$ mA                                         |
| DC $V_{CC}$ or GROUND CURRENT ( $I_{CC}$ or $I_{GND}$ )                                                   | $\pm 100$ mA*                                       |
| POWER DISSIPATION PER PACKAGE ( $P_D$ ):                                                                  |                                                     |
| For $T_A = -40$ to $+85^\circ\text{C}$ (Package Type E)                                                   | 500 mW                                              |
| For $T_A = -40$ to $+70^\circ\text{C}$ (Package Type M)                                                   | 400 mW                                              |
| For $T_A = +70$ to $+85^\circ\text{C}$ (Package Type M)                                                   | Derate Linearly at 6 mW/ $^\circ\text{C}$ to 310 mW |
| OPERATING-TEMPERATURE RANGE ( $T_A$ ): CD54                                                               | -55 to $+125^\circ\text{C}$                         |
| CD74                                                                                                      | -40 to $+85^\circ\text{C}$                          |
| STORAGE TEMPERATURE ( $T_{stg}$ )                                                                         | -65 to $+150^\circ\text{C}$                         |
| LEAD TEMPERATURE (DURING SOLDERING):                                                                      |                                                     |
| At distance $1/16 \pm 1/32$ in. ( $1.59 \pm 0.79$ mm) from case for 10 s maximum.                         | $+265^\circ\text{C}$                                |
| Unit inserted into PC board min. thickness $1/16$ in. ( $1.59$ mm) with solder contacting lead tips only. | $+300^\circ\text{C}$                                |

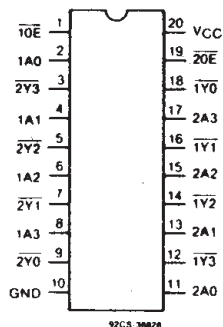
\* For up to 4 outputs per device: add  $\pm 25$  mA for each additional output.**RECOMMENDED OPERATING CONDITIONS:**

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

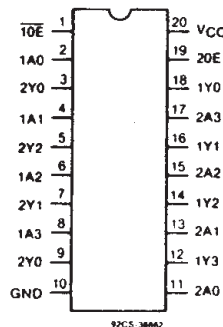
| CHARACTERISTIC                                                                    |      | LIMITS |          | UNITS            |
|-----------------------------------------------------------------------------------|------|--------|----------|------------------|
|                                                                                   |      | MIN.   | MAX.     |                  |
| Supply-Voltage Range, $V_{CC}$ *:<br>(For $T_A$ = Full Package-Temperature Range) |      |        |          |                  |
| AC Types                                                                          |      | 1.5    | 5.5      | V                |
| ACT Types                                                                         |      | 4.5    | 5.5      | V                |
| DC Input or Output Voltage, $V_I$ , $V_O$                                         |      | 0      | $V_{CC}$ | V                |
| Operating Temperature, $T_A$                                                      | CD54 | -55    | $+125$   | $^\circ\text{C}$ |
|                                                                                   | CD74 | -40    | $+85$    |                  |
| Input Rise and Fall Slew Rate, $dt/dv$                                            |      |        |          |                  |
| at 1.5 V to 3 V (AC Types)                                                        |      | 0      | 50       | ns/V             |
| at 3.6 V to 5.5 V (AC Types)                                                      |      | 0      | 20       | ns/V             |
| at 4.5 V to 5.5 V (ACT Types)                                                     |      | 0      | 10       | ns/V             |

\* Unless otherwise specified, all voltages are referenced to ground.

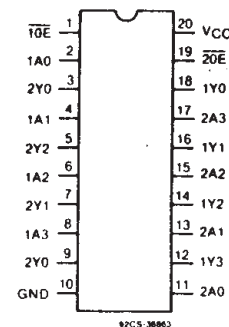
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**CD54/74AC, ACT240 TYPES**  
**TERMINAL ASSIGNMENT**



**CD54/74AC, ACT241 TYPES**  
**TERMINAL ASSIGNMENT**



**CD54/74AC, ACT244 TYPES**  
**TERMINAL ASSIGNMENT**

# CD54/74AC240/241/244

## CD54/74ACT240/241/244

## STATIC ELECTRICAL CHARACTERISTICS: AC Series

| CHARACTERISTICS                                  | TEST CONDITIONS                                                                                  |                        | V <sub>cc</sub><br>(V) | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |      |            |      |             |      | UNITS |
|--------------------------------------------------|--------------------------------------------------------------------------------------------------|------------------------|------------------------|--------------------------------------------|------|------------|------|-------------|------|-------|
|                                                  |                                                                                                  |                        |                        | +25                                        |      | -40 to +85 |      | -55 to +125 |      |       |
|                                                  | V <sub>I</sub><br>(V)                                                                            | I <sub>O</sub><br>(mA) |                        | MIN.                                       | MAX. | MIN.       | MAX. | MIN.        | MAX. |       |
| High-Level Input Voltage<br>V <sub>IH</sub>      |                                                                                                  |                        | 1.5                    | 1.2                                        | —    | 1.2        | —    | 1.2         | —    | V     |
|                                                  |                                                                                                  |                        | 3                      | 2.1                                        | —    | 2.1        | —    | 2.1         | —    |       |
|                                                  |                                                                                                  |                        | 5.5                    | 3.85                                       | —    | 3.85       | —    | 3.85        | —    |       |
| Low-Level Input Voltage<br>V <sub>IL</sub>       |                                                                                                  |                        | 1.5                    | —                                          | 0.3  | —          | 0.3  | —           | 0.3  | V     |
|                                                  |                                                                                                  |                        | 3                      | —                                          | 0.9  | —          | 0.9  | —           | 0.9  |       |
|                                                  |                                                                                                  |                        | 5.5                    | —                                          | 1.65 | —          | 1.65 | —           | 1.65 |       |
| High-Level Output Voltage<br>V <sub>OH</sub>     | V <sub>IH</sub><br>or<br>V <sub>IL</sub>                                                         | -0.05                  | 1.5                    | 1.4                                        | —    | 1.4        | —    | 1.4         | —    | V     |
|                                                  |                                                                                                  | -0.05                  | 3                      | 2.9                                        | —    | 2.9        | —    | 2.9         | —    |       |
|                                                  |                                                                                                  | -0.05                  | 4.5                    | 4.4                                        | —    | 4.4        | —    | 4.4         | —    |       |
|                                                  |                                                                                                  | -4                     | 3                      | 2.58                                       | —    | 2.48       | —    | 2.4         | —    |       |
|                                                  |                                                                                                  | -24                    | 4.5                    | 3.94                                       | —    | 3.8        | —    | 3.7         | —    |       |
|                                                  | #, *                                                                                             | -75                    | 5.5                    | —                                          | —    | 3.85       | —    | —           | —    |       |
|                                                  |                                                                                                  | -50                    | 5.5                    | —                                          | —    | —          | —    | 3.85        | —    |       |
| Low-Level Output Voltage<br>V <sub>OL</sub>      | V <sub>IH</sub><br>or<br>V <sub>IL</sub>                                                         | 0.05                   | 1.5                    | —                                          | 0.1  | —          | 0.1  | —           | 0.1  | V     |
|                                                  |                                                                                                  | 0.05                   | 3                      | —                                          | 0.1  | —          | 0.1  | —           | 0.1  |       |
|                                                  |                                                                                                  | 0.05                   | 4.5                    | —                                          | 0.1  | —          | 0.1  | —           | 0.1  |       |
|                                                  |                                                                                                  | 12                     | 3                      | —                                          | 0.36 | —          | 0.44 | —           | 0.5  |       |
|                                                  |                                                                                                  | 24                     | 4.5                    | —                                          | 0.36 | —          | 0.44 | —           | 0.5  |       |
|                                                  | #, *                                                                                             | 75                     | 5.5                    | —                                          | —    | —          | 1.65 | —           | —    |       |
|                                                  |                                                                                                  | 50                     | 5.5                    | —                                          | —    | —          | —    | —           | 1.65 |       |
| Input Leakage Current<br>I <sub>I</sub>          | V <sub>cc</sub><br>or<br>GND                                                                     |                        | 5.5                    | —                                          | ±0.1 | —          | ±1   | —           | ±1   | μA    |
| 3-State Leakage Current<br>I <sub>OZ</sub>       | V <sub>IH</sub><br>or<br>V <sub>IL</sub><br><br>V <sub>O</sub> =<br>V <sub>cc</sub><br>or<br>GND |                        | 5.5                    | —                                          | ±0.5 | —          | ±5   | —           | ±10  | μA    |
| Quiescent Supply Current, MSI<br>I <sub>cc</sub> | V <sub>cc</sub><br>or<br>GND                                                                     | 0                      | 5.5                    | —                                          | 8    | —          | 80   | —           | 160  | μA    |

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

# CD54/74AC240/241/244

## CD54/74ACT240/241/244

## STATIC ELECTRICAL CHARACTERISTICS: ACT Series

| CHARACTERISTICS                                                                     |                 | TEST CONDITIONS                               |               | $V_{CC}$<br>(V) | AMBIENT TEMPERATURE ( $T_A$ ) - °C |      |            |      |             |      | UNITS |
|-------------------------------------------------------------------------------------|-----------------|-----------------------------------------------|---------------|-----------------|------------------------------------|------|------------|------|-------------|------|-------|
|                                                                                     |                 |                                               |               |                 | +25                                |      | -40 to +85 |      | -55 to +125 |      |       |
|                                                                                     |                 | $V_i$<br>(V)                                  | $I_o$<br>(mA) |                 | MIN.                               | MAX. | MIN.       | MAX. | MIN.        | MAX. |       |
| High-Level Input Voltage                                                            | $V_{IH}$        |                                               |               | 4.5 to 5.5      | 2                                  | —    | 2          | —    | 2           | —    | V     |
| Low-Level Input Voltage                                                             | $V_{IL}$        |                                               |               | 4.5 to 5.5      | —                                  | 0.8  | —          | 0.8  | —           | 0.8  | V     |
| High-Level Output Voltage                                                           | $V_{OH}$        | $V_{IH}$ or $V_{IL}$<br>#, * {                | -0.05         | 4.5             | 4.4                                | —    | 4.4        | —    | 4.4         | —    | V     |
|                                                                                     |                 |                                               | -24           | 4.5             | 3.94                               | —    | 3.8        | —    | 3.7         | —    |       |
|                                                                                     |                 |                                               | -75           | 5.5             | —                                  | —    | 3.85       | —    | —           | —    |       |
|                                                                                     |                 |                                               | -50           | 5.5             | —                                  | —    | —          | —    | 3.85        | —    |       |
| Low-Level Output Voltage                                                            | $V_{OL}$        | $V_{IH}$ or $V_{IL}$<br>#, * {                | 0.05          | 4.5             | —                                  | 0.1  | —          | 0.1  | —           | 0.1  | V     |
|                                                                                     |                 |                                               | 24            | 4.5             | —                                  | 0.36 | —          | 0.44 | —           | 0.5  |       |
|                                                                                     |                 |                                               | 75            | 5.5             | —                                  | —    | —          | 1.65 | —           | —    |       |
|                                                                                     |                 |                                               | 50            | 5.5             | —                                  | —    | —          | —    | —           | 1.65 |       |
| Input Leakage Current                                                               | $I_i$           | $V_{CC}$ or GND                               |               | 5.5             | —                                  | ±0.1 | —          | ±1   | —           | ±1   | μA    |
| 3-State Leakage Current                                                             | $I_{OZ}$        | $V_{IH}$ or $V_{IL}$<br>$V_o = V_{CC}$ or GND |               | 5.5             | —                                  | ±0.5 | —          | ±5   | —           | ±10  | μA    |
| Quiescent Supply Current, MSI                                                       | $I_{CC}$        | $V_{CC}$ or GND                               | 0             | 5.5             | —                                  | 8    | —          | 80   | —           | 160  | μA    |
| Additional Quiescent Supply Current per Input Pin<br>TTL Inputs High<br>1 Unit Load | $\Delta I_{CC}$ | $V_{CC}-2.1$                                  |               | 4.5 to 5.5      | —                                  | 2.4  | —          | 2.8  | —           | 3    | mA    |

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#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

## ACT INPUT LOADING TABLES

| CD54/74ACT240 |             |
|---------------|-------------|
| INPUT         | UNIT LOADS* |
| nA0 - A3      | 1.42        |
| 10E           | 0.83        |
| 20E           | 0.83        |

| CD54/74ACT241 |             |
|---------------|-------------|
| INPUT         | UNIT LOADS* |
| nA0 - A3      | 0.5         |
| 10E           | 0.83        |
| 20E           | 1.67        |

| CD54/74ACT244 |             |
|---------------|-------------|
| INPUT         | UNIT LOADS* |
| nA0 - A3      | 0.5         |
| 10E           | 0.83        |
| 20E           | 0.83        |

\*Unit load is  $\Delta I_{CC}$  limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

# **CD54/74AC240/241/244** **CD54/74ACT240/241/244**

**SWITCHING CHARACTERISTICS: AC Series;  $t_r, t_f = 3 \text{ ns}$ ,  $C_L = 50 \text{ pF}$** 

| CHARACTERISTICS                                                                                         | SYMBOL                               | V <sub>CC</sub><br>(V) | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |                     |                    |                    | UNITS |
|---------------------------------------------------------------------------------------------------------|--------------------------------------|------------------------|--------------------------------------------|---------------------|--------------------|--------------------|-------|
|                                                                                                         |                                      |                        | -40 to +85                                 |                     | -55 to +125        |                    |       |
|                                                                                                         |                                      |                        | MIN.                                       | MAX.                | MIN.               | MAX.               |       |
| Propagation Delays:<br>Data to Outputs<br>AC240                                                         | t <sub>PLH</sub><br>t <sub>PHL</sub> | 1.5<br>3.3*<br>5†      | —<br>2.6<br>1.9                            | 82<br>9.2<br>6.5    | —<br>2.5<br>1.8    | 90<br>10.1<br>7.2  | ns    |
| AC241, 244                                                                                              | t <sub>PLH</sub><br>t <sub>PHL</sub> | 1.5<br>3.3<br>5        | —<br>3<br>2.2                              | 93<br>10.5<br>7.5   | —<br>2.9<br>2.1    | 103<br>11.5<br>8.2 | ns    |
| Output Enable Times                                                                                     | t <sub>PZL</sub><br>t <sub>PZH</sub> | 1.5<br>3.3<br>5        | —<br>4.6<br>3.1                            | 136<br>16.4<br>10.9 | —<br>4.5<br>3      | 150<br>18<br>12    | ns    |
| Output Disable Times                                                                                    | t <sub>PLZ</sub><br>t <sub>PHZ</sub> | 1.5<br>3.3<br>5        | —<br>3.9<br>3.1                            | 136<br>13.6<br>10.9 | —<br>3.8<br>3      | 150<br>15<br>12    | ns    |
| Power Dissipation Capacitance<br>AC240<br>AC241, 244                                                    | C <sub>PD</sub> §                    | —<br>—                 | 65 Typ.<br>71 Typ.                         |                     | 65 Typ.<br>71 Typ. |                    | pF    |
| Min. (Valley) V <sub>OH</sub><br>During Switching of Other Outputs<br>(Output Under Test Not Switching) | V <sub>OHV</sub><br>See<br>Fig. 1    | 5                      | 4 Typ. @ 25°C                              |                     |                    |                    | V     |
| Max. (Peak) V <sub>OL</sub><br>During Switching of Other Outputs<br>(Output Under Test Not Switching)   | V <sub>OLP</sub><br>See<br>Fig. 1    | 5                      | 1 Typ. @ 25°C                              |                     |                    |                    | V     |
| Input Capacitance                                                                                       | C <sub>i</sub>                       | —                      | —                                          | 10                  | —                  | 10                 | pF    |
| 3-State Output Capacitance                                                                              | C <sub>o</sub>                       | —                      | —                                          | 15                  | —                  | 15                 | pF    |

**SWITCHING CHARACTERISTICS: ACT Series;  $t_r, t_f = 3 \text{ ns}$ ,  $C_L = 50 \text{ pF}$** 

| CHARACTERISTICS                                                                                         | SYMBOL                               | V <sub>CC</sub><br>(V) | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |      |                    |      | UNITS |
|---------------------------------------------------------------------------------------------------------|--------------------------------------|------------------------|--------------------------------------------|------|--------------------|------|-------|
|                                                                                                         |                                      |                        | -40 to +85                                 |      | -55 to +125        |      |       |
|                                                                                                         |                                      |                        | MIN.                                       | MAX. | MIN.               | MAX. |       |
| Propagation Delays:<br>Data to Outputs<br>ACT240                                                        | t <sub>PLH</sub><br>t <sub>PHL</sub> | 5†                     | 2.3                                        | 7.8  | 2.2                | 8.6  | ns    |
| ACT241, 244                                                                                             | t <sub>PLH</sub><br>t <sub>PHL</sub> | 5                      | 2.5                                        | 8.7  | 2.4                | 9.6  | ns    |
| Output Enable Times                                                                                     | t <sub>PZL</sub><br>t <sub>PZH</sub> | 5                      | 3.5                                        | 12.2 | 3.4                | 13.4 | ns    |
| Output Disable Times                                                                                    | t <sub>PLZ</sub><br>t <sub>PHZ</sub> | 5                      | 3.5                                        | 12.2 | 3.4                | 13.4 | ns    |
| Power Dissipation Capacitance<br>ACT240<br>ACT241, 244                                                  | C <sub>PD</sub> §                    | —<br>—                 | 65 Typ.<br>71 Typ.                         |      | 65 Typ.<br>71 Typ. |      | pF    |
| Min. (Valley) V <sub>OH</sub><br>During Switching of Other Outputs<br>(Output Under Test Not Switching) | V <sub>OHV</sub><br>See<br>Fig. 1    | 5                      | 4 Typ. @ 25°C                              |      |                    |      | V     |
| Max. (Peak) V <sub>OL</sub><br>During Switching of Other Outputs<br>(Output Under Test Not Switching)   | V <sub>OLP</sub><br>See<br>Fig. 1    | 5                      | 1 Typ. @ 25°C                              |      |                    |      | V     |
| Input Capacitance                                                                                       | C <sub>I</sub>                       | —                      | —                                          | 10   | —                  | 10   | pF    |
| 3-State Output Capacitance                                                                              | C <sub>O</sub>                       | —                      | —                                          | 15   | —                  | 15   | pF    |

\*3.3 V: min. is @ 3.6 V  
max. is @ 3 V

†5 V: min. is @ 5.5 V  
max. is @ 4.5 V

‡ $C_{PD}$  is used to determine the dynamic power consumption, per package.

For AC series:  $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$

For ACT series:  $P_D = V_{CC}^2 f_i (C_{PD} + C_L) + V_{CC} \Delta I_{CC}$  where  $f_i$  = input frequency

$C_L$  = output load capacitance

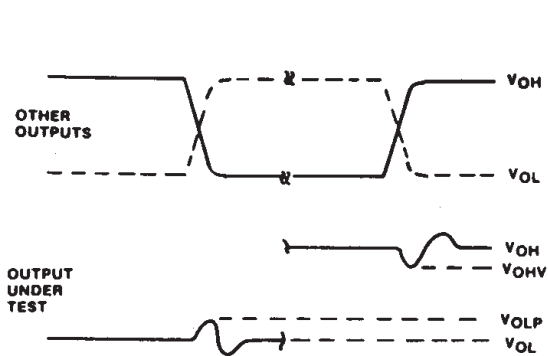
$V_{CC}$  = supply voltage.

# Technical Data

## CD54/74AC240/241/244

## CD54/74ACT240/241/244

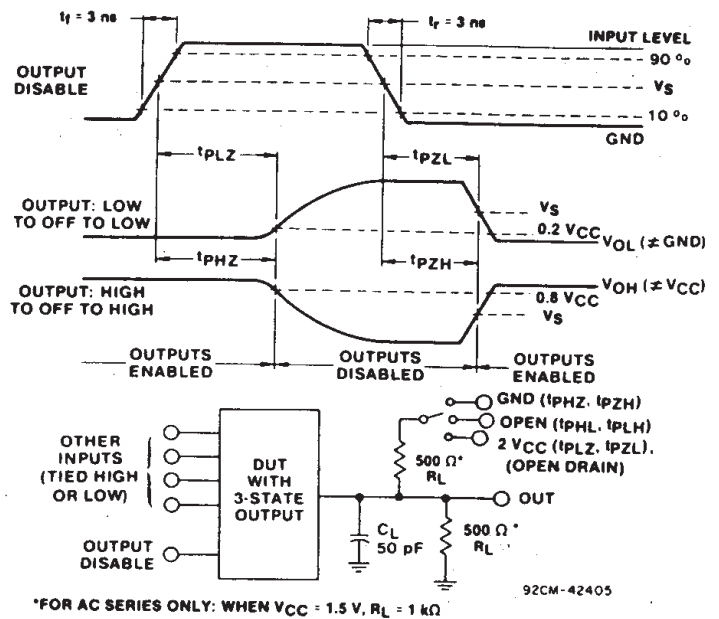
### PARAMETER MEASUREMENT INFORMATION



#### NOTES:

1.  $V_{OHV}$  and  $V_{OLP}$  ARE MEASURED WITH RESPECT TO A GROUND REFERENCE NEAR THE OUTPUT UNDER TEST.
2. INPUT PULSES HAVE THE FOLLOWING CHARACTERISTICS:  
 $PRR \leq 1 \text{ MHz}$ ,  $t_f = 3 \text{ ns}$ ,  $t_r = 3 \text{ ns}$ , SKEW 1 ns.
3. R.F. FIXTURE WITH 700-MHz DESIGN RULES REQUIRED. IC SHOULD BE SOLDERED INTO TEST BOARD AND BYPASSED WITH  $0.1 \mu\text{F}$  CAPACITOR. SCOPE AND PROBES REQUIRE 700-MHz BANDWIDTH.

92CS-42406

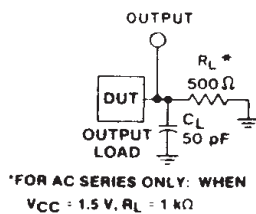


92CM-42405

\*FOR AC SERIES ONLY: WHEN  $V_{CC} = 1.5 \text{ V}$ ,  $R_L = 1 \text{ k}\Omega$

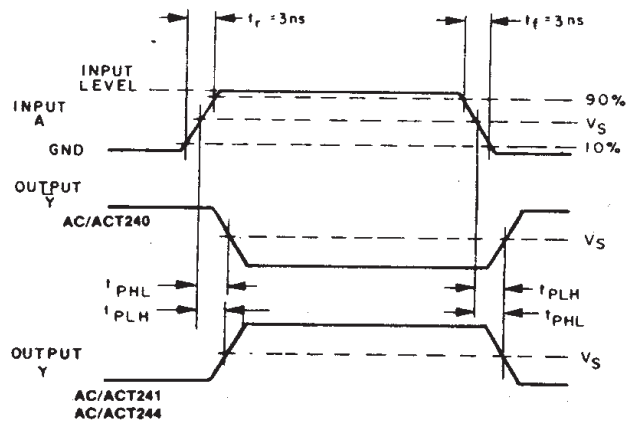
Fig. 1 - Simultaneous switching transient waveforms.

Fig. 2 - Three-state propagation delay times and test circuit.



\*FOR AC SERIES ONLY: WHEN  $V_{CC} = 1.5 \text{ V}$ ,  $R_L = 1 \text{ k}\Omega$

92CS-42389



92CS-42407

Fig. 3 - Propagation delay times and test circuit.

|                                 | CD54/74AC    | CD54/74ACT   |
|---------------------------------|--------------|--------------|
| Input Level                     | $V_{CC}$     | 3 V          |
| Input Switching Voltage, $V_S$  | $0.5 V_{CC}$ | 1.5 V        |
| Output Switching Voltage, $V_S$ | $0.5 V_{CC}$ | $0.5 V_{CC}$ |

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| CD54AC240F3A     | ACTIVE                | CDIP         | J               | 20   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| CD54AC244F3A     | ACTIVE                | CDIP         | J               | 20   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| CD54ACT240F3A    | ACTIVE                | CDIP         | J               | 20   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| CD54ACT241F3A    | ACTIVE                | CDIP         | J               | 20   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| CD54ACT244F3A    | ACTIVE                | CDIP         | J               | 20   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| CD74AC240E       | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74AC240EE4     | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74AC240M       | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC240M96     | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC240M96E4   | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC240M96G4   | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC240ME4     | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC240MG4     | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC244E       | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74AC244EE4     | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74AC244M       | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC244M96     | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC244M96E4   | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC244M96G4   | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC244ME4     | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC244MG4     | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC244SM96    | ACTIVE                | SSOP         | DB              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC244SM96E4  | ACTIVE                | SSOP         | DB              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC244SM96G4  | ACTIVE                | SSOP         | DB              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT240E      | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT240EE4    | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT240M      | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| CD74ACT240M96    | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT240M96E4  | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT240M96G4  | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT240ME4    | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT240MG4    | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT241E      | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT241EE4    | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT241M96    | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT241M96E4  | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT241M96G4  | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT244E      | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT244EE4    | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT244M      | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT244M96    | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT244M96E4  | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT244M96G4  | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT244ME4    | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT244MG4    | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT244SM96   | ACTIVE                | SSOP         | DB              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT244SM96E4 | ACTIVE                | SSOP         | DB              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT244SM96G4 | ACTIVE                | SSOP         | DB              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

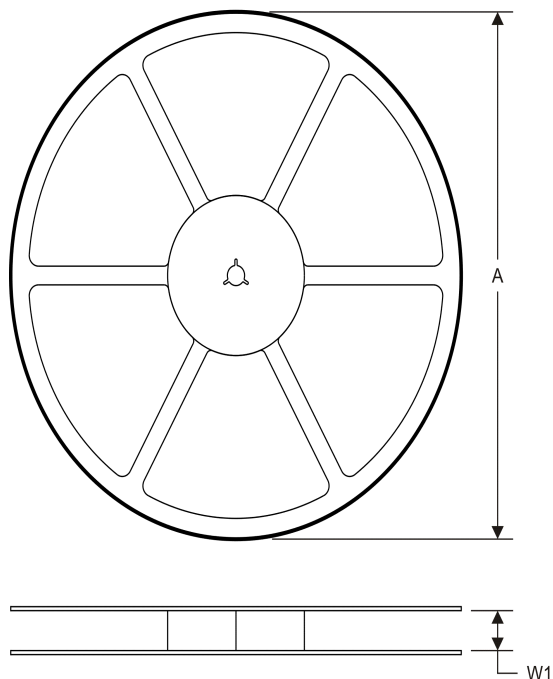
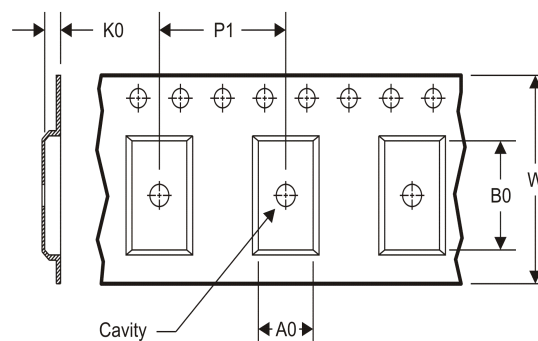
**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

**TAPE DIMENSIONS**


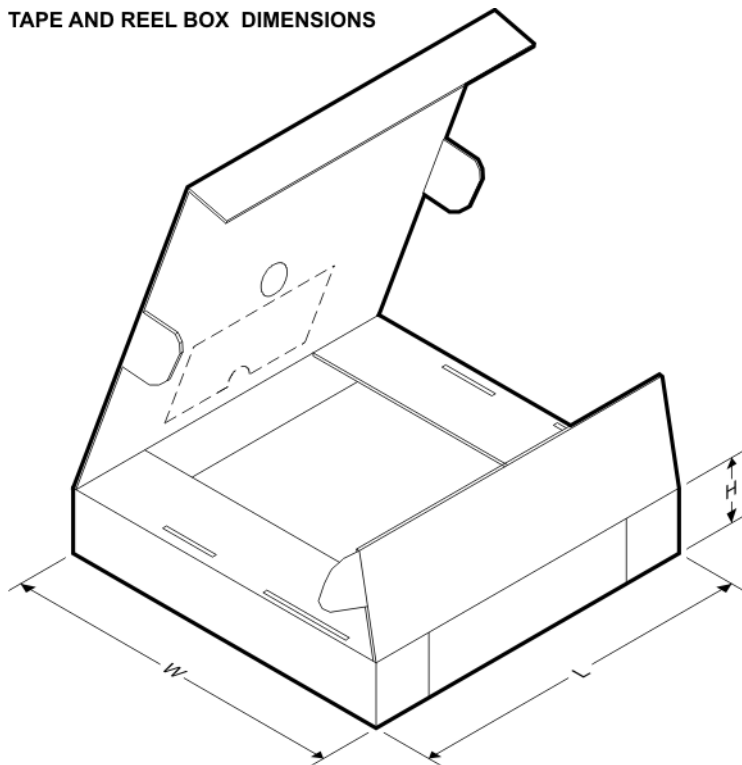
|    |                                                           |
|----|-----------------------------------------------------------|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD74AC240M96   | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.0    | 2.7     | 12.0    | 24.0   | Q1            |
| CD74AC244M96   | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.0    | 2.7     | 12.0    | 24.0   | Q1            |
| CD74AC244SM96  | SSOP         | DB              | 20   | 2000 | 330.0              | 16.4               | 8.2     | 7.5     | 2.5     | 12.0    | 16.0   | Q1            |
| CD74ACT240M96  | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.0    | 2.7     | 12.0    | 24.0   | Q1            |
| CD74ACT241M96  | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.0    | 2.7     | 12.0    | 24.0   | Q1            |
| CD74ACT244M96  | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.0    | 2.7     | 12.0    | 24.0   | Q1            |
| CD74ACT244SM96 | SSOP         | DB              | 20   | 2000 | 330.0              | 16.4               | 8.2     | 7.5     | 2.5     | 12.0    | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



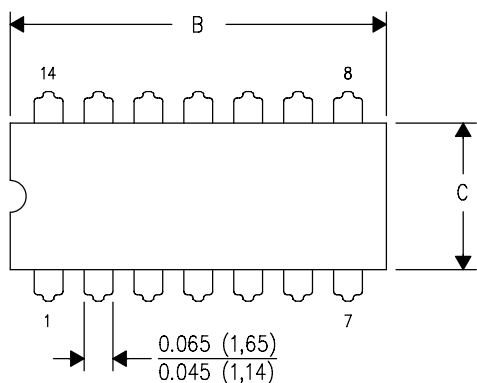
\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74AC240M96   | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74AC244M96   | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74AC244SM96  | SSOP         | DB              | 20   | 2000 | 367.0       | 367.0      | 38.0        |
| CD74ACT240M96  | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74ACT241M96  | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74ACT244M96  | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74ACT244SM96 | SSOP         | DB              | 20   | 2000 | 367.0       | 367.0      | 38.0        |

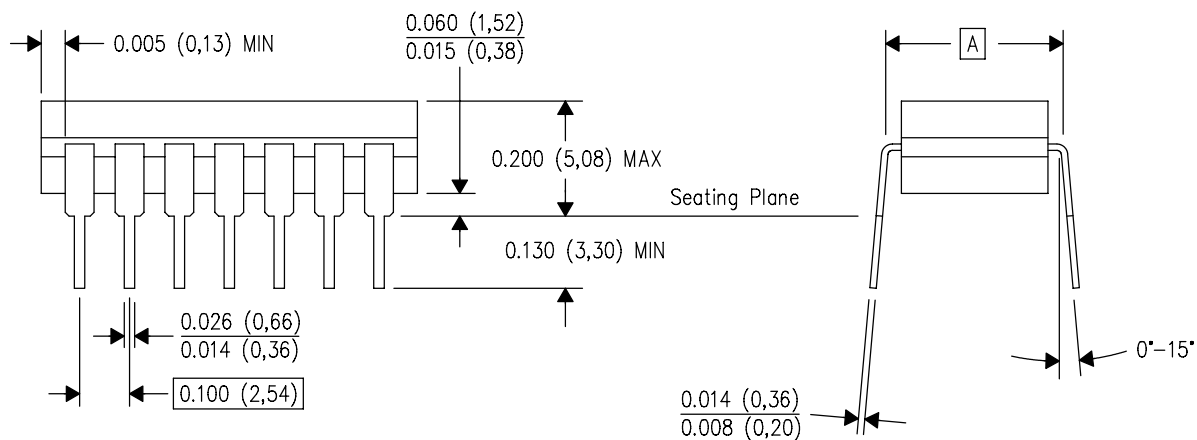
J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



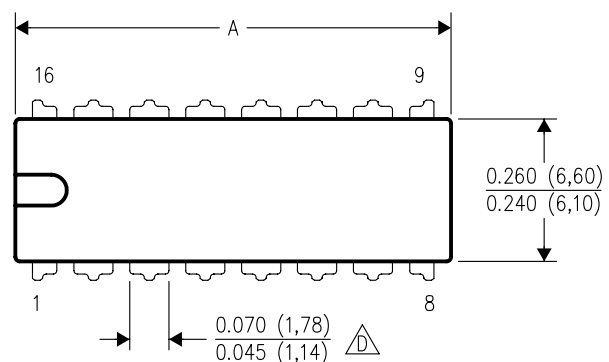
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

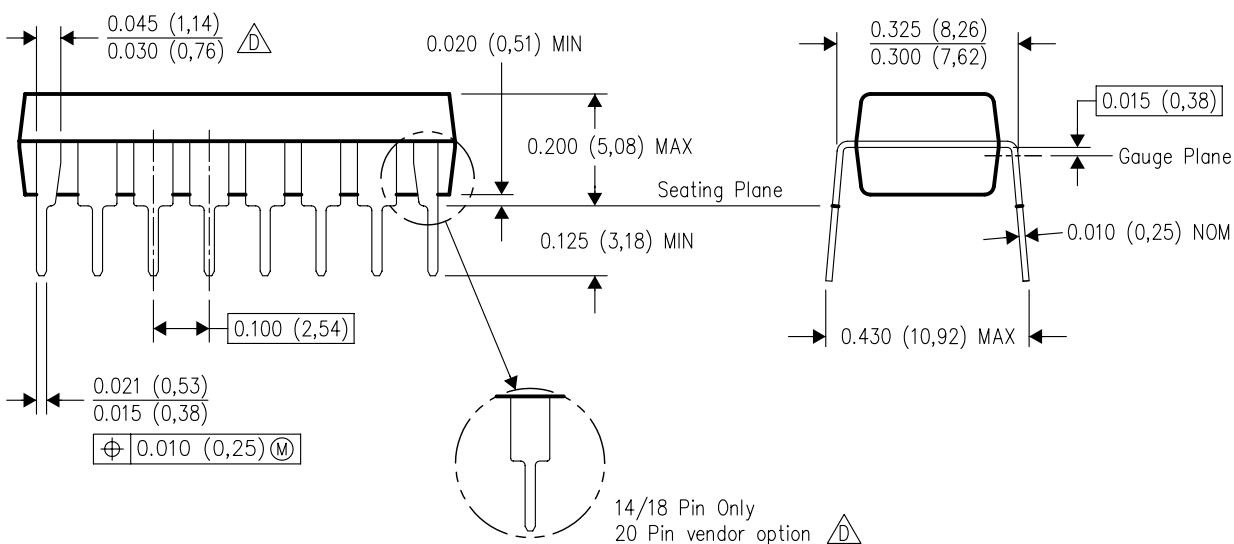
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



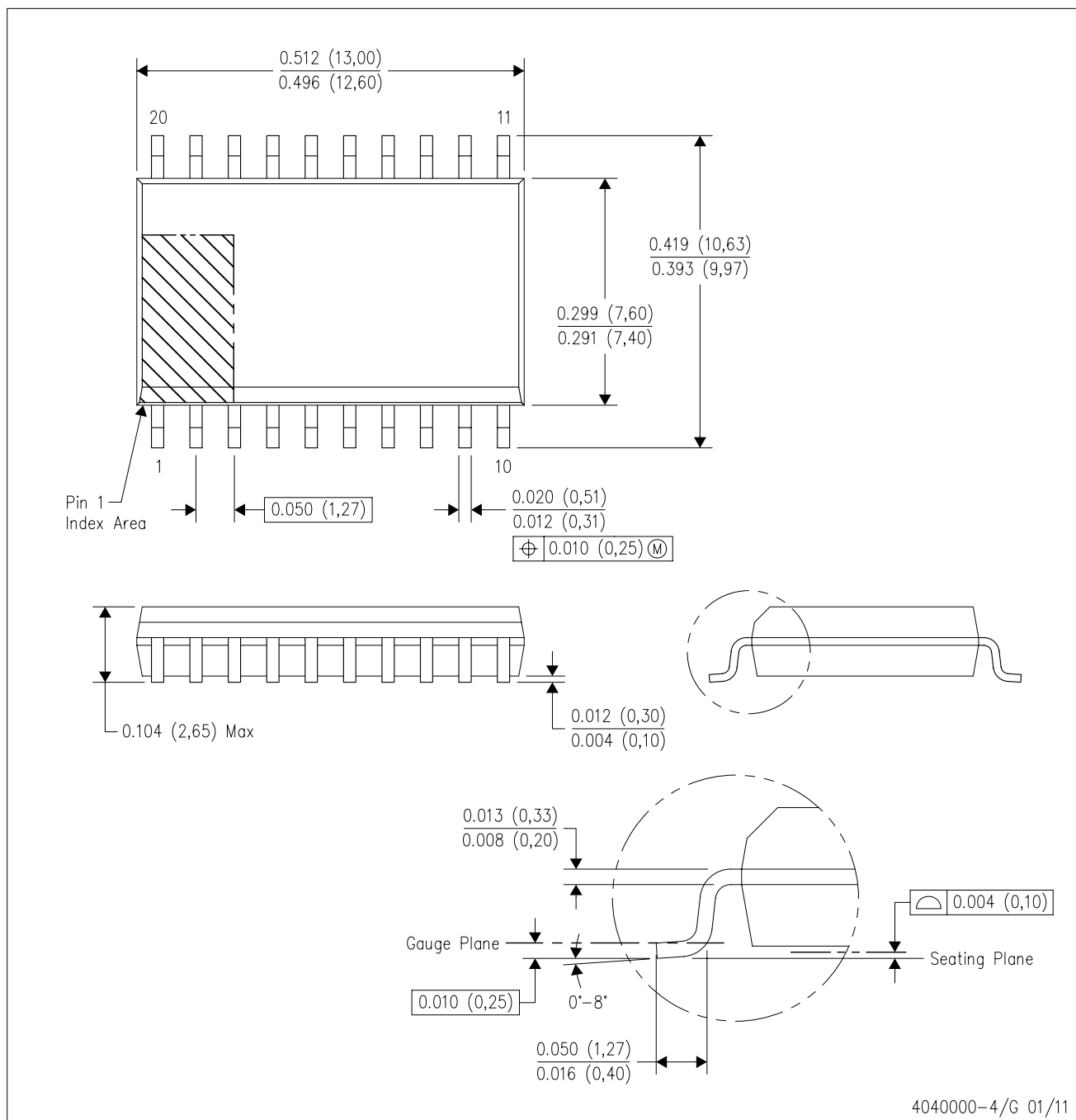
4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G20)

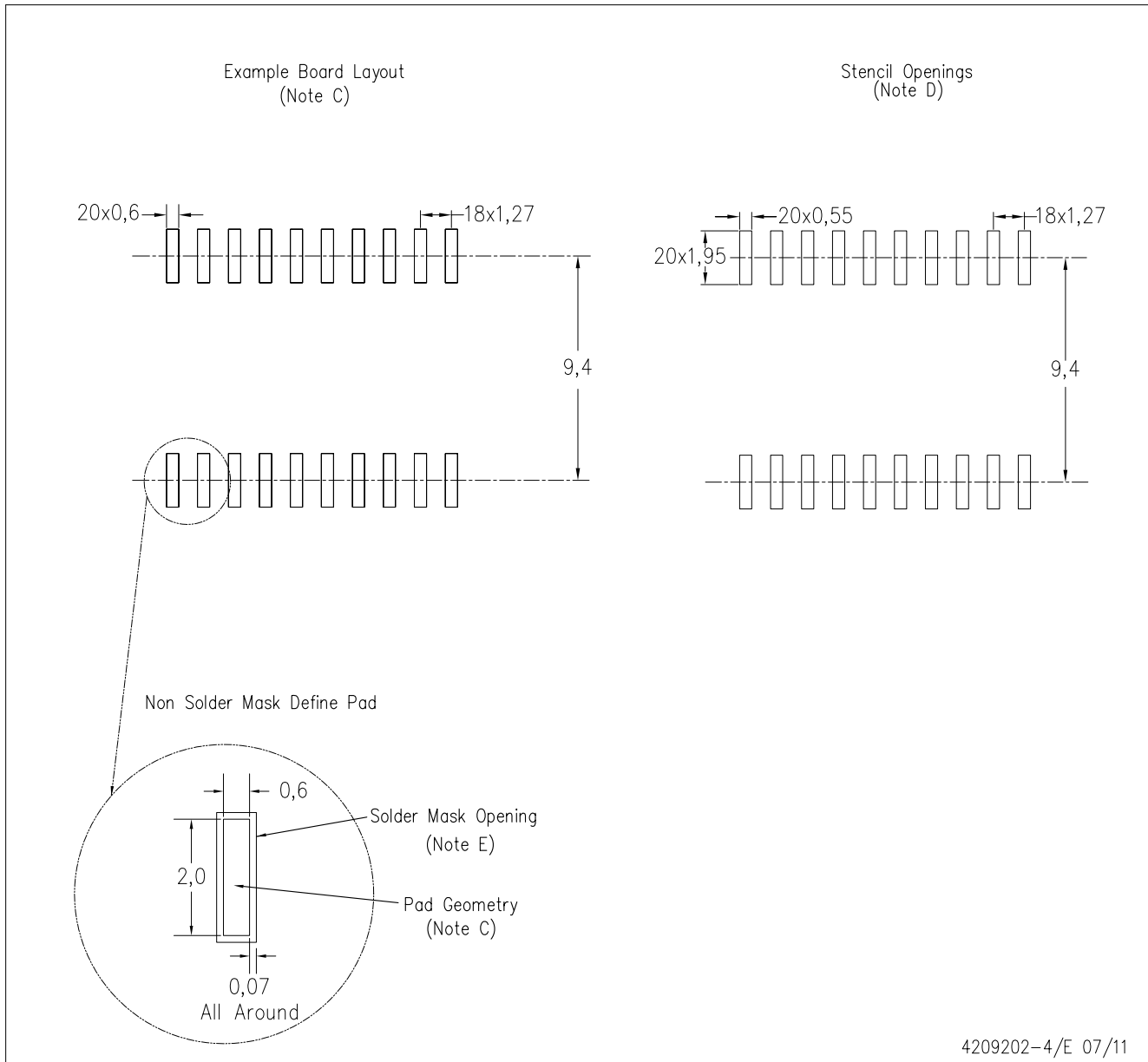
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AC.

DW (R-PDSO-G20)

PLASTIC SMALL OUTLINE

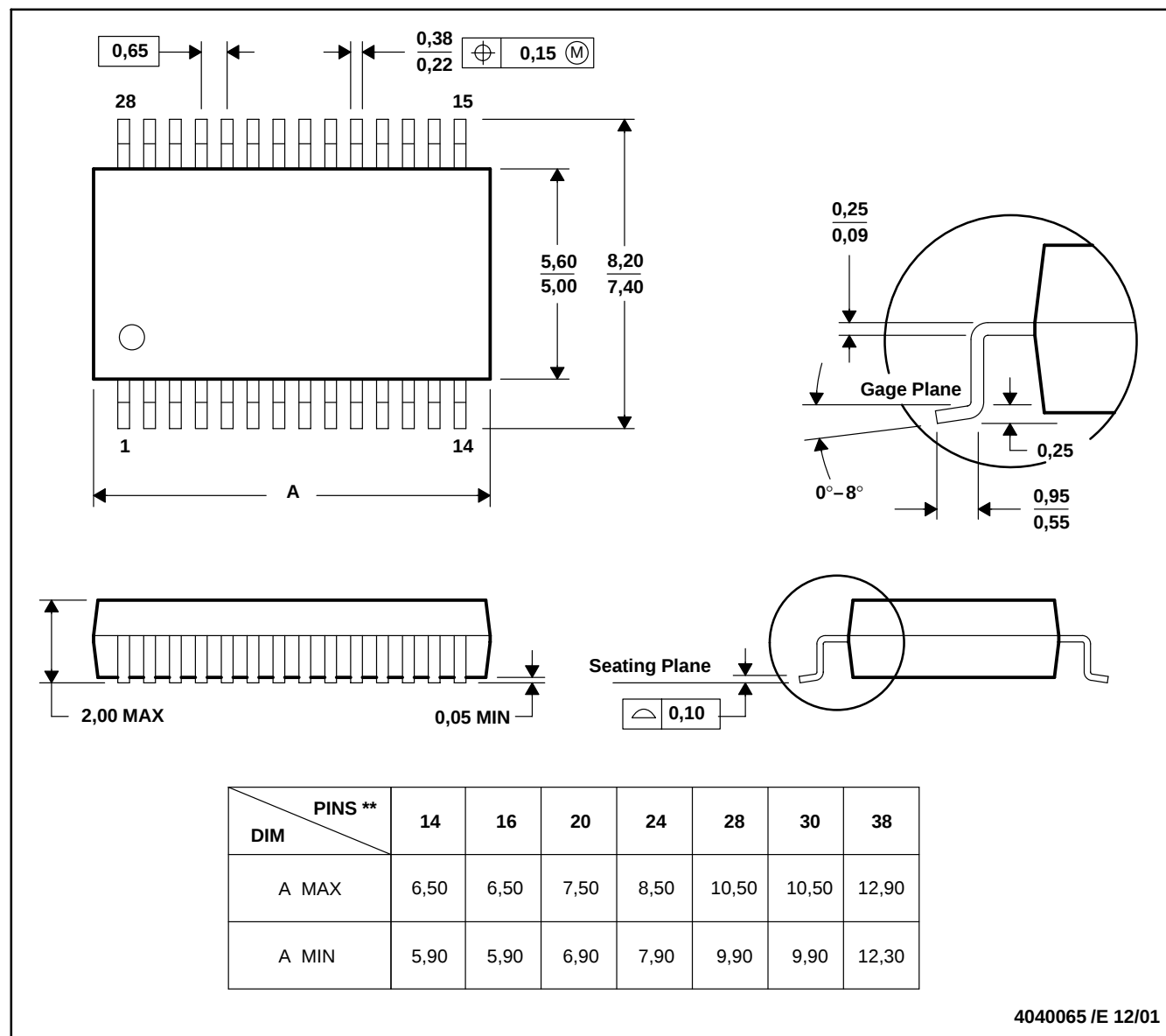


- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

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| DLP® Products          | <a href="http://www.dlp.com">www.dlp.com</a>                                         |
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| Interface              | <a href="http://interface.ti.com">interface.ti.com</a>                               |
| Logic                  | <a href="http://logic.ti.com">logic.ti.com</a>                                       |
| Power Mgmt             | <a href="http://power.ti.com">power.ti.com</a>                                       |
| Microcontrollers       | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a>                   |
| RFID                   | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
| OMAP Mobile Processors | <a href="http://www.ti.com/omap">www.ti.com/omap</a>                                 |
| Wireless Connectivity  | <a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a> |

### Applications

|                               |                                                                                          |
|-------------------------------|------------------------------------------------------------------------------------------|
| Automotive and Transportation | <a href="http://www.ti.com/automotive">www.ti.com/automotive</a>                         |
| Communications and Telecom    | <a href="http://www.ti.com/communications">www.ti.com/communications</a>                 |
| Computers and Peripherals     | <a href="http://www.ti.com/computers">www.ti.com/computers</a>                           |
| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
| Industrial                    | <a href="http://www.ti.com/industrial">www.ti.com/industrial</a>                         |
| Medical                       | <a href="http://www.ti.com/medical">www.ti.com/medical</a>                               |
| Security                      | <a href="http://www.ti.com/security">www.ti.com/security</a>                             |
| Space, Avionics and Defense   | <a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a> |
| Video and Imaging             | <a href="http://www.ti.com/video">www.ti.com/video</a>                                   |

**TI E2E Community** [e2e.ti.com](http://e2e.ti.com)

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: [ocean@oceanchips.ru](mailto:ocean@oceanchips.ru)

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А